Priority Appl. N . 09/995,372

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## Amendments to the Sp\_cification

Please replace the title with the following new title.

Semiconductor Processing Methods of Forming Photoresist over Silicon Nitride

Materials, and Semiconductor Wafer Assemblies Comprising Photoresist over Silicon

Nitride Materials

At page 1, please replace the Related Patent Data section with the following new Related Patent Data Section.

## **RELATED PATENT DATA**

This application resulted from a continuation application from U.S. Patent P.L. (p. 693.345)

Application Serial No. 09/995,372, filed on November 26, 2001, which resulted from a continuation application of U.S. Patent Application Serial No. 09/724,749, which was filed on November 27, 2000, now U.S. Patent No. 6,417,559 which is a divisional application of U.S. Patent Application Serial No. 09/457,093, which was filed December 7, 1999, now U.S. Patent No. 6,323,139 This application which is a continuation-in-part of U.S. Patent Application Serial No. 09/057,155, filed April 7, 1998, now U.S. Patent No. 6,300,253; and a continuation-in-part of U.S. Patent Application Serial No. 09/295,642, filed April 20, 1999 now U.S. Patent No. 6,297,171; which is a continuation of U.S. Patent Application Serial No. 08/567,090, now U.S. Patent No. 5,926,739.

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